

SPECIFICATION

Device Name : IGBT-IPM

Type Name : 7MBP50RTJ060

Spec. No. : MS6M0672

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Fuji Electric Co., Ltd.
Matsumoto Factory

	DATE	NAME	APPROVED	Fuji Electric Co., Ltd.		
DRAWN	Jan-16-03	N. Matsuda	7. Fujishiro	DWG. NO.	MS6M0672	
CHECKED	16-Jan-03	Mishiro				1/23
CHECKED	16-Jan-03	K. Yamada				

2 . Pin Descriptions

Main circuit

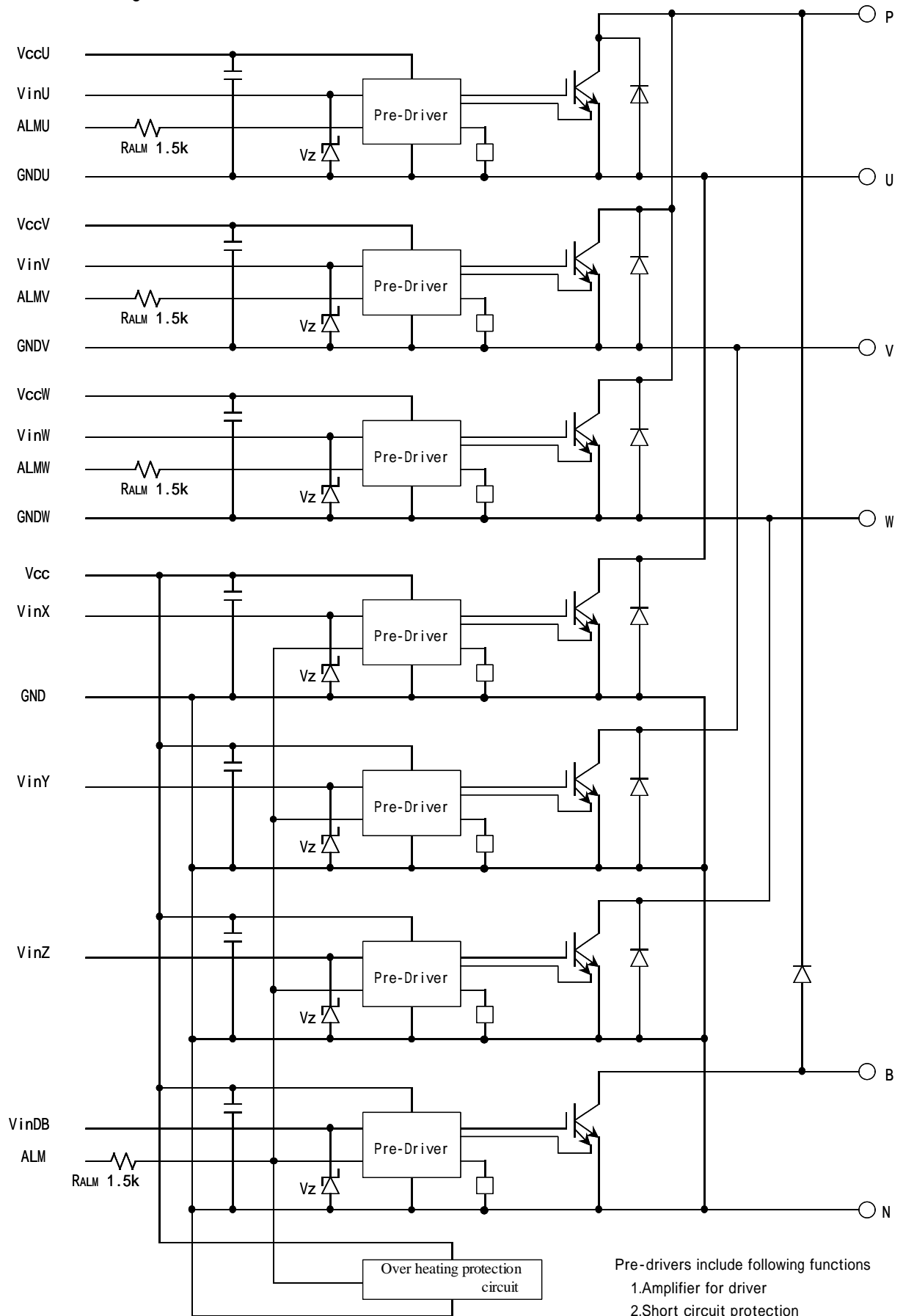
Symbol	Description
P	Positive input supply voltage.
U	Output (U).
V	Output (V).
W	Output (W).
N	Negative input supply voltage.
B	Collector terminal of Brake IGBT.

Control circuit

	Symbol	Description
	GNDU	High side ground (U).
	ALMU	Alarm signal output (U).
	VinU	Logic input for IGBT gate drive (U).
	VccU	High side supply voltage (U).
	GNDV	High side ground (V).
	ALMV	Alarm signal output (V).
	VinV	Logic input for IGBT gate drive (V).
	VccV	High side supply voltage (V).
	GNDW	High side ground (W).
	ALMW	Alarm signal output (W).
	VinW	Logic input for IGBT gate drive (W).
	VccW	High side supply voltage (W).
	GND	Low side ground.
	Vcc	Low side supply voltage.
	VinDB	Logic input for Brake IGBT gate drive.
	VinX	Logic input for IGBT gate drive (X).
	VinY	Logic input for IGBT gate drive (Y).
	VinZ	Logic input for IGBT gate drive (Z).
	ALM	Low side alarm signal output.

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3. Block Diagram



- Pre-drivers include following functions
1. Amplifier for driver
 2. Short circuit protection
 3. Under voltage lockout circuit
 4. Over current protection
 5. IGBT chip over heating protection

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4 . Absolute Maximum Ratings

Tc = 25 unless otherwise specified.

Items		Symbol	Min.	Max.	Units
Bus Voltage (between terminal P and N)	DC	V _{DC}	0	450	V
	Surge	V _{DC(surge)}	0	500	V
	Shortoperating	V _{sc}	200	400	V
Collector-Emitter Voltage *1		V _{ces}	0	600	V
Inverter	Collector Current	DC	I _c	50	A
		1ms	I _{cp}	100	A
		Duty=76.1% *2	-I _c	50	A
	Collector Power Dissipation	One transistor *3	P _c	144	W
Brake	Collector Current	DC	I _c	30	A
		1ms	I _{cp}	60	A
	Forward Current of Diode		I _F	30	A
	Collector Power Dissipation	One transistor *3	P _c	144	W
Supply Voltage of Pre-Driver *4		V _{cc}	-0.5	20	V
Input Signal Voltage *5		V _{in}	-0.5	V _{cc} +0.5	V
Input Signal Current		I _{in}		3	mA
Alarm Signal Voltage *6		V _{ALM}	-0.5	V _{cc}	V
Alarm Signal Current *7		I _{ALM}		20	mA
Junction Temperature		T _j		150	
Operating Case Temperature		T _{opr}	-20	100	
Storage Temperature		T _{stg}	-40	125	
Isolating Voltage (Terminal to base, 50/60Hz sine wave 1min.) *8		V _{iso}		AC2500	V
Screw Torque	Terminal (M5)			3.5	Nm
	Mounting (M5)				

Note

- *1 : V_{ces} shall be applied to the input voltage between terminal P and U or V or W or DB, N and U or V or W or DB
- *2 : $125 / \text{FWD } R_{th(j-c)} / (I_c \times V_F \text{ MAX}) = 125 / 1.263 / (50 \times 2.6) \times 100 = 76.1\%$
- *3 : P_c=125 / IGBT R_{th(j-c)}=125/0.87=144W [Inverter]
P_c=125 / IGBT R_{th(j-c)}=125/0.87=144W [Break]
- *4 : V_{CC} shall be applied to the input voltage between terminal No.4 and 1, 8 and 5, 12 and 9, 14 and 13
- *5 : V_{in} shall be applied to the input voltage between terminal No.3 and 1, 7 and 5, 11 and 9, 15,16,17,18 and 13 .
- *6 : V_{ALM} shall be applied to the voltage between terminal No.2 and 1, No6 and 5, No10 and 9, No.19 and 13 .
- *7 : I_{ALM} shall be applied to the input current to terminal No.2,6,10 and 19 .
- *8 : 50Hz/60Hz sine wave 1 minute.

Fuji Electric Co.,Ltd.

DWG. NO.

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5 . Electrical Characteristics

T_j = 25 , V_{cc} = 15V unless otherwise specified.

5.1 Main circuit

Item		Symbol	Conditions	Min.	Typ.	Max.	Units	
Inverter	Collector Current at off signal input	ICES	V _{CE} = 600V Vin terminal open.	-	-	1.0	mA	
	Collector-Emitter saturation voltage	VCE(sat)	Ic = 50A	Terminal	-	-	2.5	V
				Chip	-	2.0	-	V
	Forward voltage of FWD	VF	-Ic = 50A	Terminal	-	-	2.6	V
Chip				-	1.6	-	V	
Brake	Collector Current at off signal input	ICES	V _{CE} = 600V Vin terminal open.	-	-	1.0	mA	
	Collector-Emitter saturation voltage	VCE(sat)	Ic = 30A	Terminal	-	-	2.2	V
				Chip	-	1.75	-	V
	Forward voltage of Diode	VF	-Ic = 30A	Terminal	-	-	3.3	V
Chip				-	1.9	-	V	
Turn-on time	ton	V _{DC} = 300V, T _j =125	1.2	-	-	us		
Turn-off time	toff	Ic = 50A Fig.1 , Fig.6	-	-	3.6			
Reverse recovery time	trr	V _{DC} = 300V IF = 50A Fig.1 , Fig.6	-	-	0.3			
Maximum Avalanche Energy (A non-repetition)	PAV	internal wiring inductance = 50nH Main circuit wiring inductance = 54nH	30	-	-	mJ		

5.2 Control circuit

Item	Symbol	Conditions	Min.	Typ.	Max.	Units
Supply current of P-side pre-driver (one unit)	Iccp	Switching Frequency: 0 ~ 15kHz	-	-	18	mA
Supply current of N-side pre-driver	Iccn	Tc = -20 ~ 125 Fig.7	-	-	65	mA
Input signal threshold voltage	Vin(th)	ON	1.00	1.35	1.70	V
		OFF	1.25	1.60	1.95	
Input Zener Voltage	Vz	Rin = 20k	-	8.0	-	V
Alarm Signal Hold Time	tALM	Tc = -20 Fig.2	1.1	-	-	ms
		Tc = 25 Fig.2	-	2.0	-	ms
		Tc = 125 Fig.2	-	-	4.0	ms
Limiting Resistor for Alarm	RALM		1425	1500	1575	

5.3 Protection Section (Vcc = 15V)

Item	Symbol	Conditions	Min.	Typ.	Max.	Units
Over Current Protection Level of Inverter circuit	loc	Tj=125	75	-	-	A
Over Current Protection Level of Brake circuit		Tj=125	45	-	-	A
Over Current Protection Delay time	tdoc	Tj=125	-	5	-	us
SC Protection Delay time	tsc	Tj=125 Fig.4	-	-	8	us
IGBT Chips Over Heating Protection Temperature Level	TjOH	Surface of IGBT Chips	150	-	-	
Over Heating Protection Hysteresis	TjH		-	20	-	
Over Heating Protection Temperature Level	TcOH	VDC=0V,IC=0A CaseTemperature	110	-	125	
Over Heating Protection Hysteresis	TcH		-	20	-	
Under Voltage Protection Level	VUV		11.0	-	12.5	V
Under Voltage Protection Hysteresis	VH		0.2	0.5	-	

6. Thermal Characteristics (Tc = 25 °C)

Item	Symbol	Min.	Typ.	Max.	Units	
Junction to Case Thermal Resistance *9	Inverter IGBT	Rth(j-c)	-	-	0.87	/W
	FWD	Rth(j-c)	-	-	1.263	
	Brake IGBT	Rth(j-c)	-	-	0.87	
Case to Fin Thermal Resistance with Compound	Rth(c-f)	-	0.05	-		

7. Noise Immunity (Vdc=300V, Vcc=15V, Test Circuit Fig 5.)

Item	Conditions	Min.	Typ.	Max.	Units
Common mode rectangular noise	Pulse width 1us, polarity ±, 10 minuts Judge: no over-current, no miss operating	± 2.0	-	-	kV
Common mode lightning surge	Rise time 1.2us, Fall time 50us Interval 20s, 10 times Judge : no over-current, no miss operating	± 5.0	-	-	kV

8. Recommended Operating Conditions

Item	Symbol	Min.	Typ.	Max.	Units
DC Bus Voltage	VDC	-	-	400	V
Power Supply Voltage of Pre-Driver	Vcc	13.5	15.0	16.5	V
Screw Torque (M5)	-	2.5	-	3.0	Nm

9. Weight

Item	Symbol	Min.	Typ.	Max.	Units
Weight	Wt	-	450	-	g

*9: (For 1device , Case is under the device)

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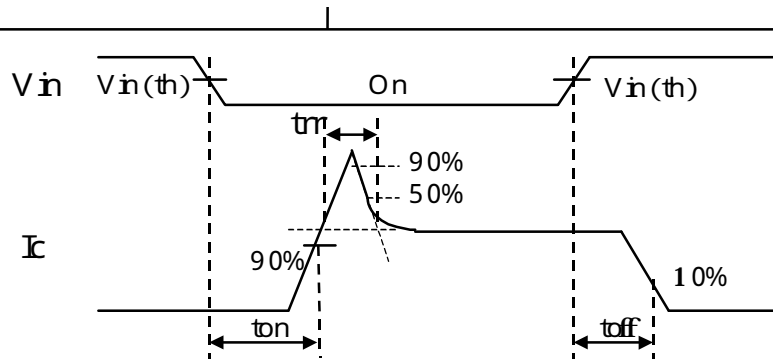
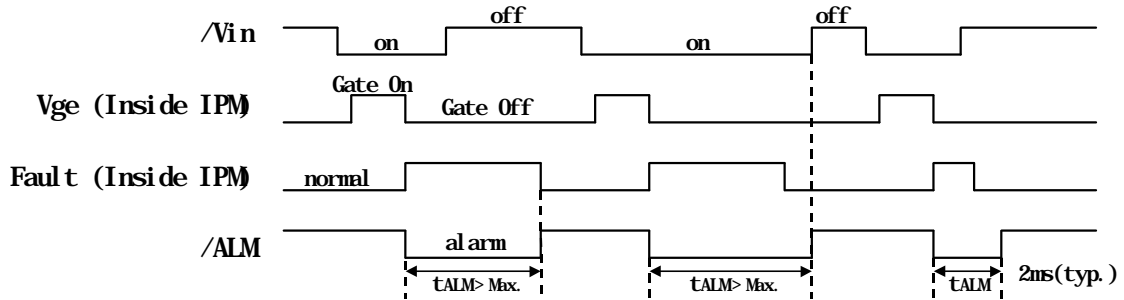


Figure 1. Switching Time Waveform Definitions



Fault : Over-current, Over-heat or Under-voltage

Figure 2. Input/Output Timing Diagram

Necessary conditions for alarm reset (refer to to in figure2.)

This represents the case when a failure-causing Fault lasts for a period more than t_{ALM} . The alarm resets when the input V_{in} is OFF and the Fault has disappeared.

This represents the case when the ON condition of the input V_{in} lasts for a period more than t_{ALM} . The alarm resets when the V_{in} turns OFF under no Fault conditions.

This represents the case when the Fault disappears and the V_{in} turns OFF within t_{ALM} . The alarm resets after lasting for a period of the specified time t_{ALM} .

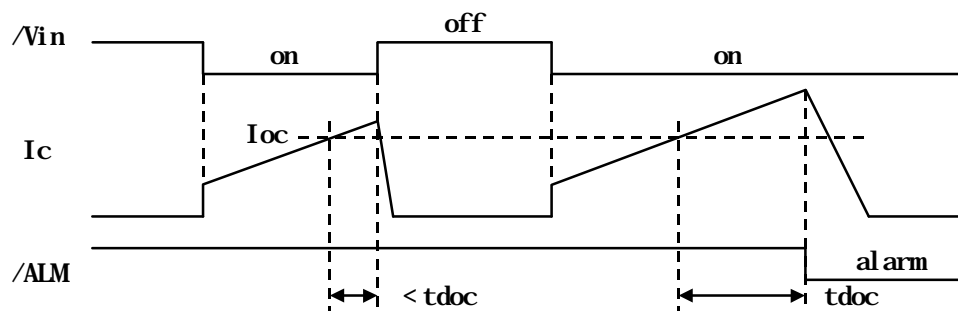


Figure 3. Over-current Protection Timing Diagram

Period : When a collector current over the OC level flows and the OFF command is input within a period less than the trip delay time t_{doc} , the current is hard-interrupted and no alarm is output.

Period : When a collector current over the OC level flows for a period more than the trip delay time t_{doc} , the current is soft-interrupted. If this is detected at the lower arm IGBTs, an alarm is output.

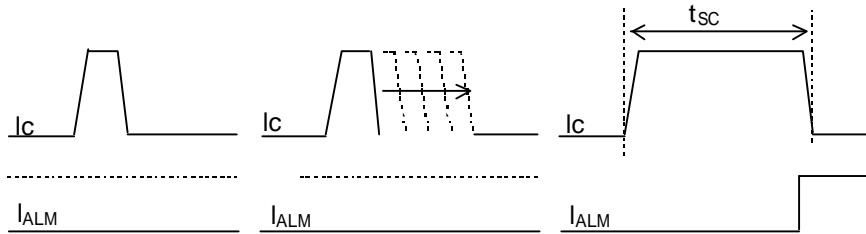


Figure.4 Definition of t_{sc}

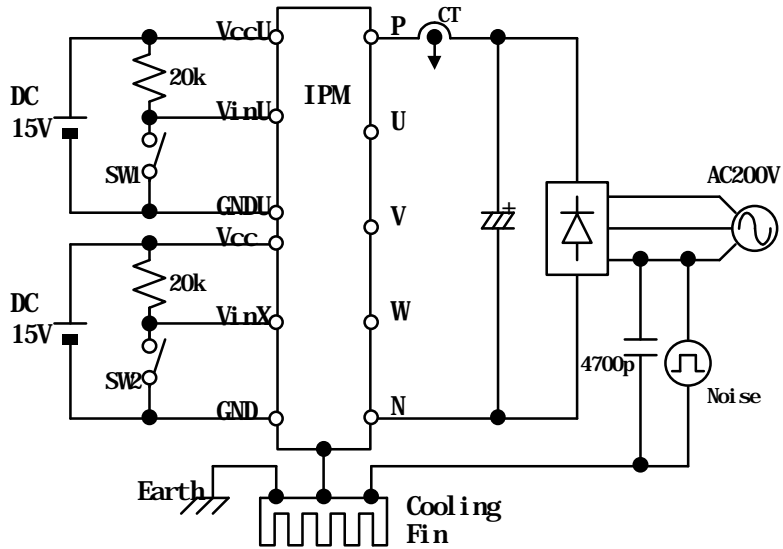


Figure 5. Noise Test Circuit

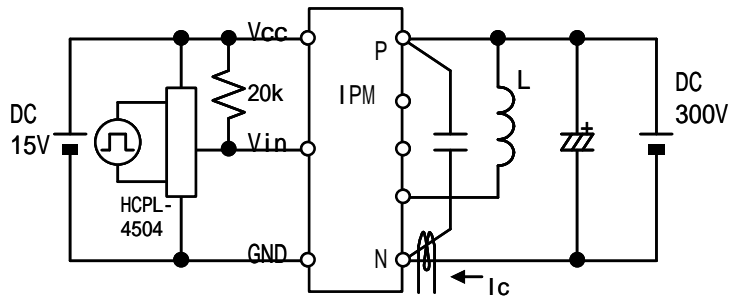


Figure 6. Switching Characteristics Test Circuit

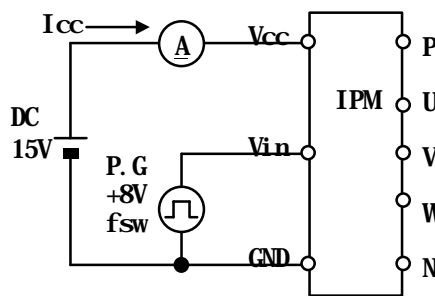


Figure 7. I_{cc} Test Circuit

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10. Truth table

10.1 IGBT Control

The following table shows the IGBT ON/OFF status with respect to the input signal Vin.
The IGBT turn-on when Vin is at “Low” level under no alarm condition.

Input (Vin)	Output (IGBT)
Low	ON
High	OFF

10.2 Fault Detection

- (1) When a fault is detected at the high side, only the detected arm stops its output. At that time the IPM outputs detected arm's alarm.
- (2) When a fault is detected at the low side, all the lower arms stop their outputs and the IPM outputs an alarm of the low side.

	Fault	IGBT				Alarm Output			
		U-phase	V-phase	W-phase	Low side	ALM-U	ALM-V	ALM-W	ALM
High side U-phase	OC	OFF	*	*	*	L	H	H	H
	UV	OFF	*	*	*	L	H	H	H
	TjOH	OFF	*	*	*	L	H	H	H
High side V-phase	OC	*	OFF	*	*	H	L	H	H
	UV	*	OFF	*	*	H	L	H	H
	TjOH	*	OFF	*	*	H	L	H	H
High side W-phase	OC	*	*	OFF	*	H	H	L	H
	UV	*	*	OFF	*	H	H	L	H
	TjOH	*	*	OFF	*	H	H	L	H
Low side	OC	*	*	*	OFF	H	H	H	L
	UV	*	*	*	OFF	H	H	H	L
	TjOH	*	*	*	OFF	H	H	H	L
Case Temperature	TcOH	*	*	*	OFF	H	H	H	L

* : Depend on input logic.

11. Cautions for design and application

1. Trace routing layout should be designed with particular attention to least stray capacity between the primary and secondary sides of optical isolators by minimizing the wiring length between the optical isolators and the IPM input terminals as possible.

フォトカプラとIPMの入力端子間の配線は極力短くし、フォトカプラの一次側と二次側の浮遊容量を小さくしたパターンレイアウトにしてください。

2. Mount a capacitor between Vcc and GND of each high-speed optical isolator as close to as possible. 高速フォトカプラの Vcc-GND 間に、コンデンサを出来るだけ近接して取り付けてください。

3. For the high-speed optical isolator, use high-CMR type one with tpHL, tpLH 0.8μs.

高速フォトカプラは、tpHL, tpLH 0.8us、高 CMR タイプをご使用ください。

4. For the alarm output circuit, use low-speed type optical isolators with CTR 100%.

アラーム出力回路は、低速フォトカプラ CTR 100%のタイプをご使用ください。

5. For the control power Vcc, use four power supplies isolated each. And they should be designed to reduce the voltage variations.

制御電源 Vcc は、絶縁された4電源を使用してください。また、電圧変動を抑えた設計として下さい。

6. Suppress surge voltages as possible by reducing the inductance between the DC bus P and N, and connecting some capacitors between the P and N terminals

P-N間の直流母線は出来るだけ低インダクタンス化し、P-N端子間にコンデンサを接続するなどしてサージ電圧を低減して下さい。

7. To prevent noise intrusion from the AC lines, connect a capacitor of some 4700pF between the three-phase lines each and the ground.

ACラインからのノイズ侵入を防ぐために、3相各線 - アース間に4700pF程のコンデンサを接続して下さい。

8. At the external circuit, never connect the control terminal GNDU to the main terminal U-phase, GNDV to V-phase, GNDW to W-phase, and GND to N-phase. Otherwise, malfunctions may be caused.

制御端子 GNDUと主端子U相、制御端子 GNDVと主端子V相、制御端子 GNDWと主端子W相

制御端子 GNDと主端子Nを外部回路で接続しないで下さい。誤動作の原因になります。

9. Take note that an optical isolator's response to the primary input signal becomes slow if a capacitor is connected between the input terminal and GND.

入力端子-GND間にコンデンサを接続すると、フォトカプラ一次側入力信号に対する応答時間が長くなりますのでご注意ください。

10. Taking the used isolator's CTR into account, design with a sufficient allowance to decide the primary forward current of the optical isolator.

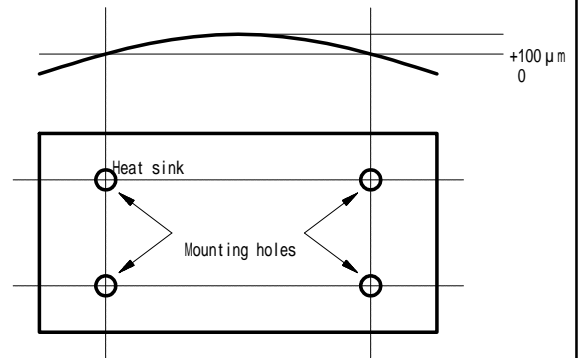
フォトカブラの一次側電流は、お使いのフォトカブラの CTR を考慮し十分に余裕をもった設計にしてください。

11. Apply thermal compound to the surfaces between the IPM and its heat sink to reduce the thermal contact resistance.

接触熱抵抗を小さくするために、IPMとヒートシンクの間にはサーマルコンパウンドを塗布して下さい。

12. Finish the heat sink surface within roughness of $10\mu\text{m}$ and flatness (camber) between screw positions of 0 to $+100\mu\text{m}$. If the flatness is minus, the heat radiation becomes worse due to a gap between the heat sink and the IPM. And, if the flatness is over $+100\mu\text{m}$, there is a danger that the IPM copper base may be deformed and this may cause a dielectric breakdown.

ヒートシンク表面の仕上げは、粗さ $10\mu\text{m}$ 以下、ネジ位置間での平坦度(反り)は $0\sim 100\mu\text{m}$ として下さい。平坦度がマイナスの場合、ヒートシンクと IPM の間に隙間ができ放熱が悪化します。また、平坦度が $+100\mu\text{m}$ 以上の場合 IPM の銅ベースが変形し絶縁破壊を起こす危険性があります。



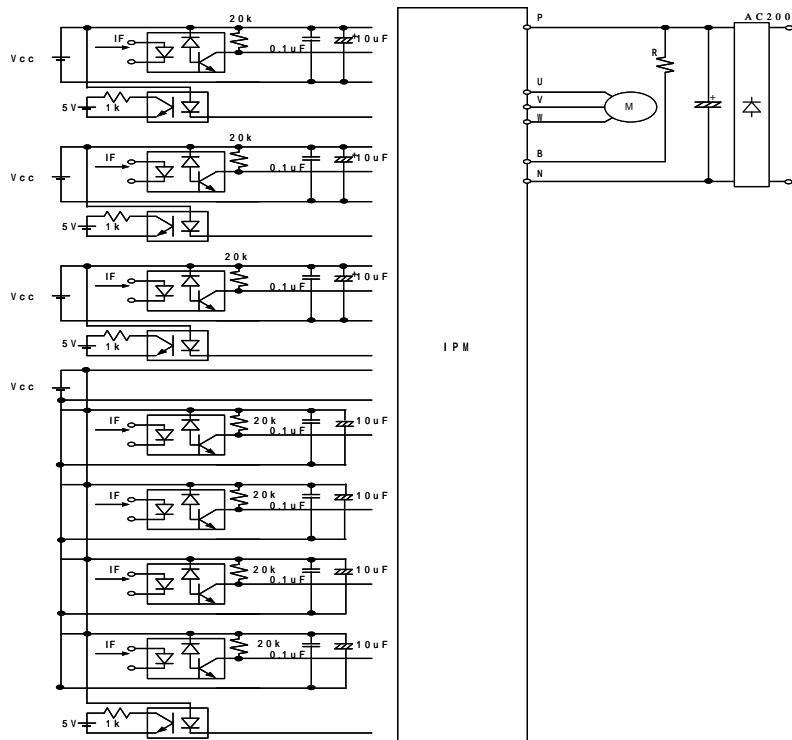
13. This product is designed on the assumption that it applies to an inverter use. Sufficient examination is required when applying to a converter use. Please contact Fuji Electric Co., Ltd if you would like to applying to converter use.

本製品は、インバータ用途への適用を前提に設計されております。コンバータ用途へ適用される場合は、十分な検討が必要です。もし、コンバータへ適用される場合は御連絡ください。

14. Please see the 『Fuji IGBT-IPM R SERIES APPLICATION MANUAL』 and 『Fuji IGBT MODULES N SERIES APPLICATION MANUAL』.

『富士 IGBT-IPM R シリーズ アプリケーションマニュアル』及び『IGBT モジュール N シリーズ アプリケーションマニュアル』を御参照ください。

1 2 . Example of applied circuit 応用回路例



The alarm signals should be connected to Vcc when it is not used.
 不使用のアラーム端子は、制御電源 Vcc に接続して下さい。

1 3 . Package and Marking 梱包仕様

Please see the MT6M4140 which is packing specification of P610 & P611& P621 package .
 P 6 1 0 , 6 1 1 , 6 2 1 梱包仕様書 MT 6 M 4 1 4 0 を御参照ください。

1 4 . Cautions for storage and transportation 保管、運搬上の注意

- Store the modules at the normal temperature and humidity (5 to 35°C, 45 to 75%).
 常温常湿(5~35、45~75%)で保存して下さい。
- Avoid a sudden change in ambient temperature to prevent condensation on the module surfaces. モジュールの表面が結露しないよう、急激な温度変化を避けて下さい。
- Avoid places where corrosive gas generates or much dust exists.
 腐食性ガスの発生場所、粉塵の多い場所は避けて下さい。
- Store the module terminals under unprocessed conditions
 モジュールの端子は未加工の状態での保管すること。
- Avoid physical shock or falls during the transportation.
 運搬時に衝撃を与えたり落下させないで下さい。

1 5 . Scope of application 適用範囲

This specification is applied to the IGBT-IPM (type: 7MBP50RTJ060).
 本仕様書は、IGBT-IPM (型式 : 7MBP50RTJ060)に適用する。

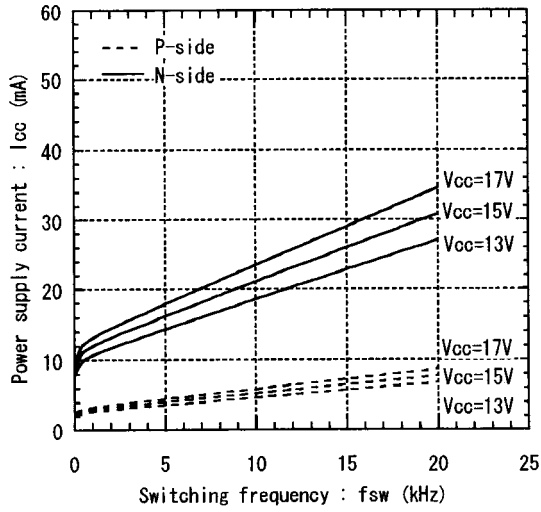
1 6 . Based safety standards 準拠安全規格

UL1557

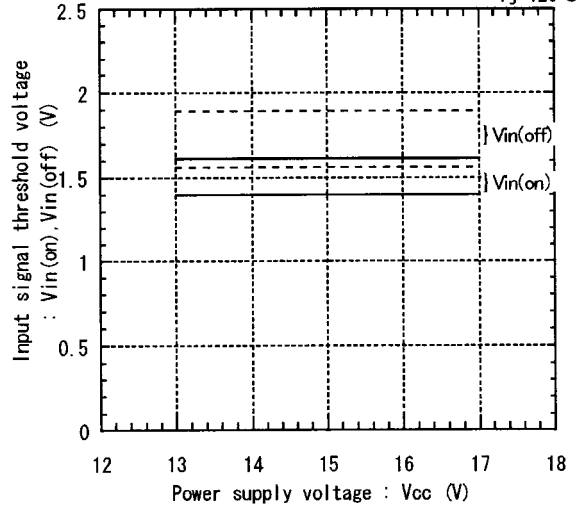
17. Characteristics

17-1. Control Circuit Characteristics (Representative)

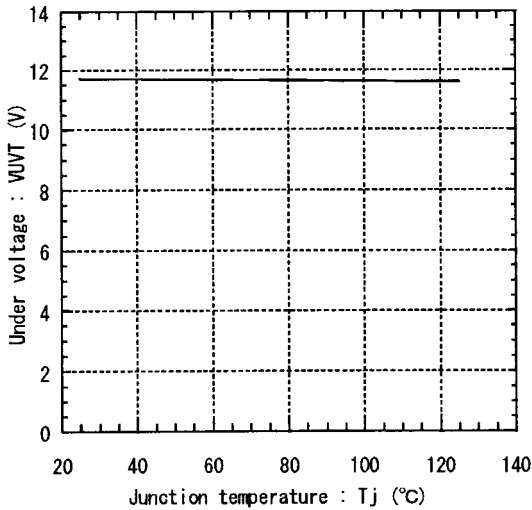
Power supply current vs. Switching frequency
Tc=125°C



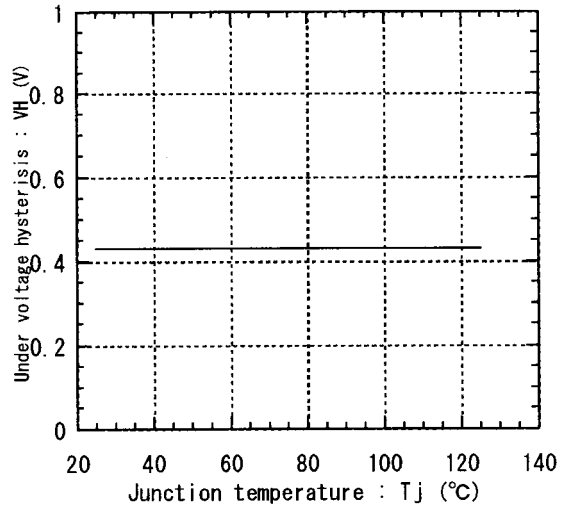
Input signal threshold voltage vs. Power supply voltage
Tj=25°C (solid line), Tj=125°C (dashed line)



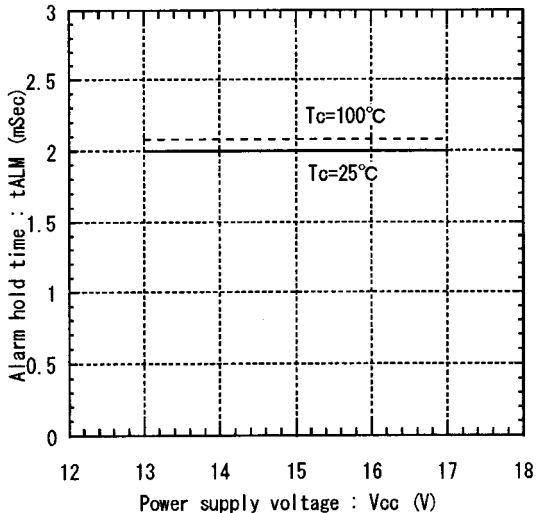
Under voltage vs. Junction temperature



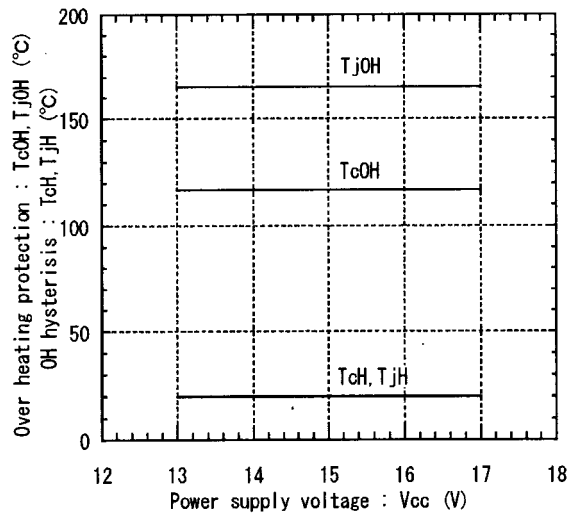
Under voltage hysteresis vs. Junction temperature



Alarm hold time vs. Power supply voltage



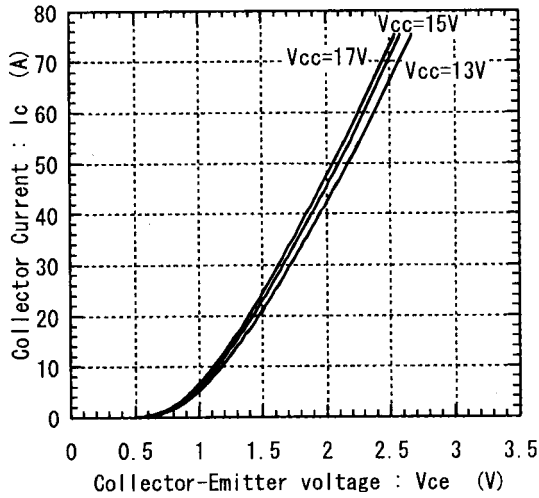
Over heating characteristics
TcOH, TjOH, TcH, TjH vs. Vcc



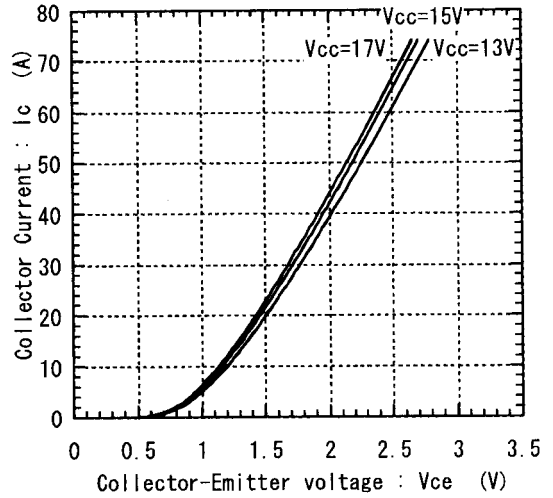
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17-2. Main Circuit Characteristics (Representative)

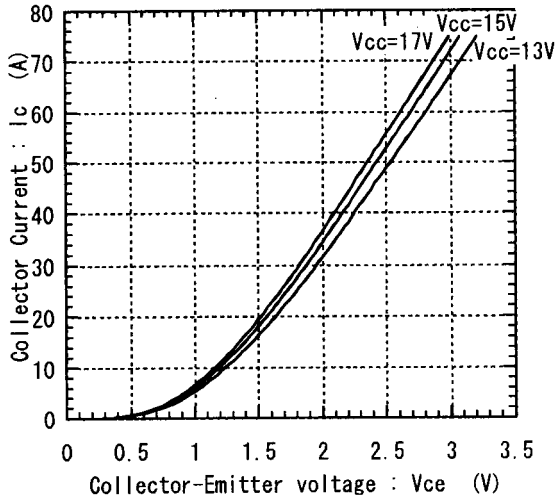
Collector current vs. Collector-Emitter voltage
T_j=25°C (Chip)



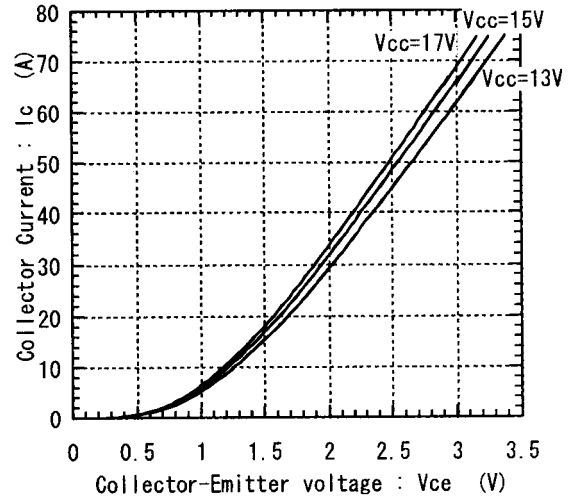
Collector current vs. Collector-Emitter voltage
T_j=25°C (Terminal)



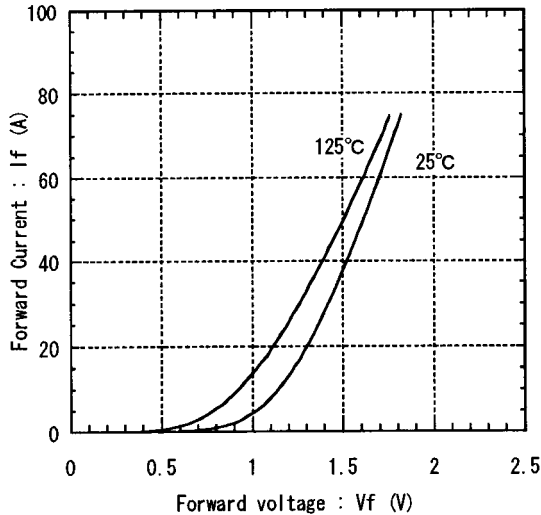
Collector current vs. Collector-Emitter voltage
T_j=125°C (Chip)



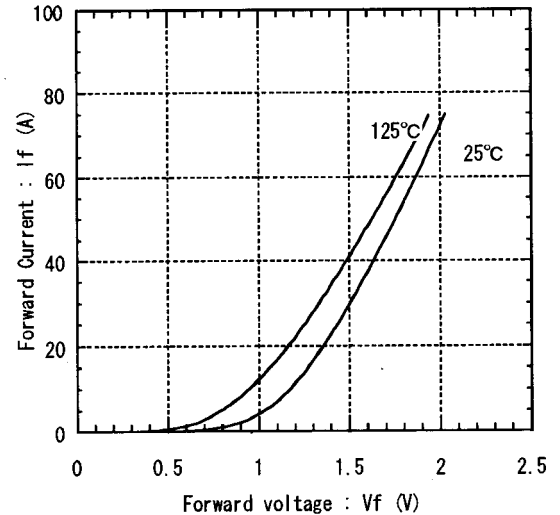
Collector current vs. Collector-Emitter voltage
T_j=125°C (Terminal)



Forward current vs. Forward voltage
(Chip)

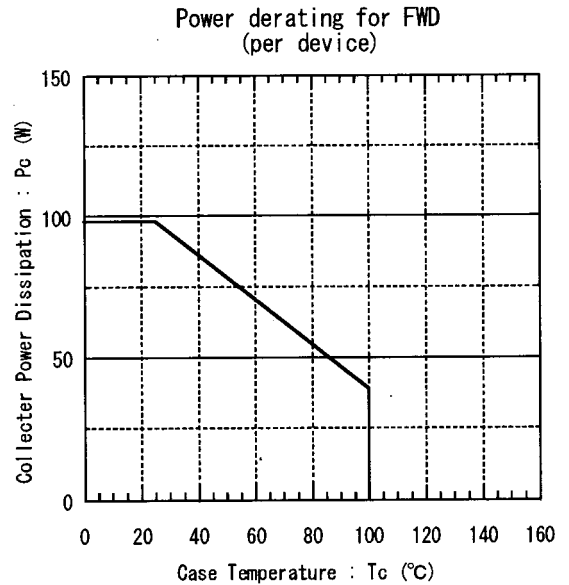
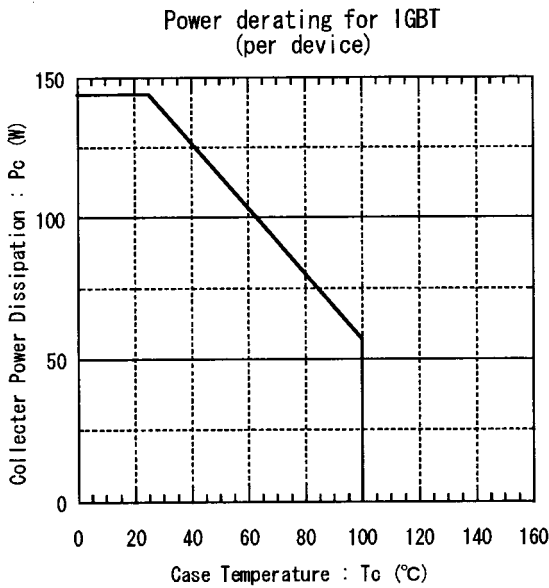
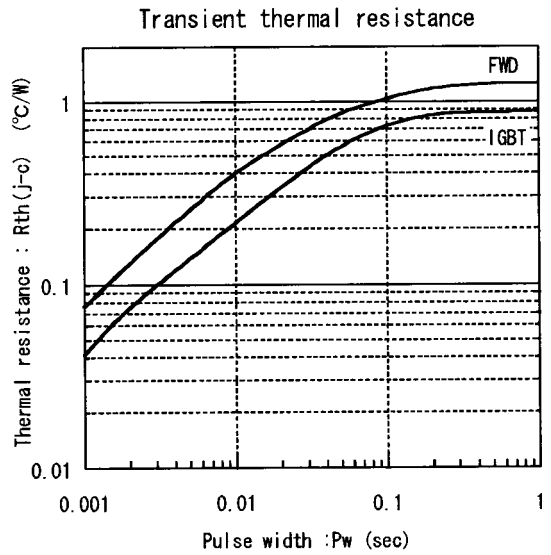
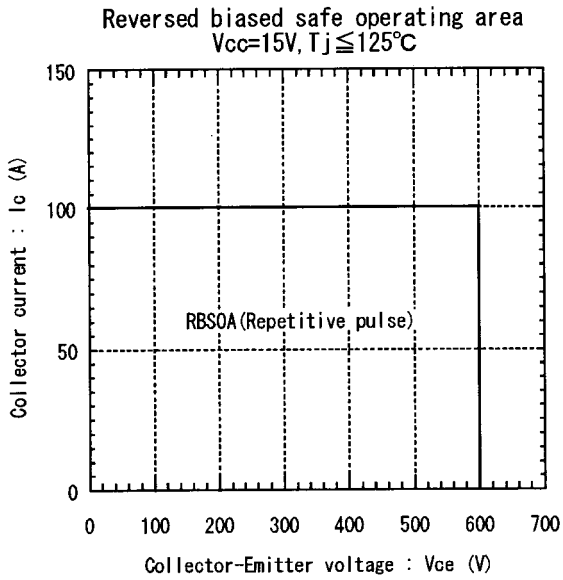
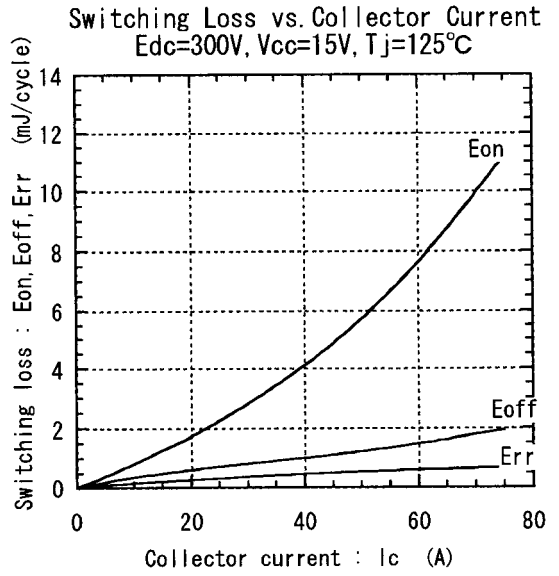
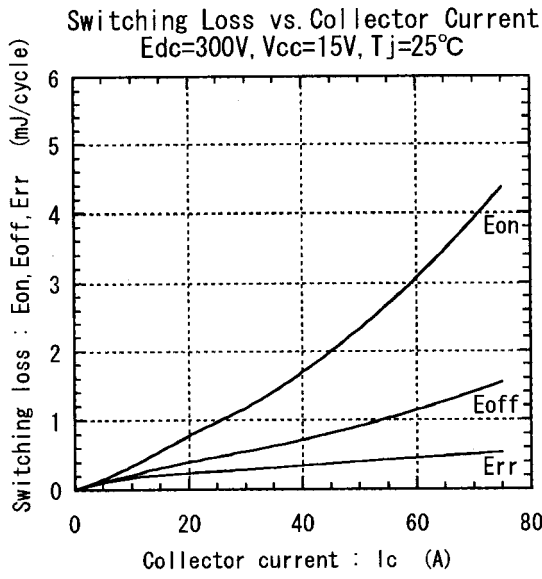


Forward current vs. Forward voltage
(Terminal)



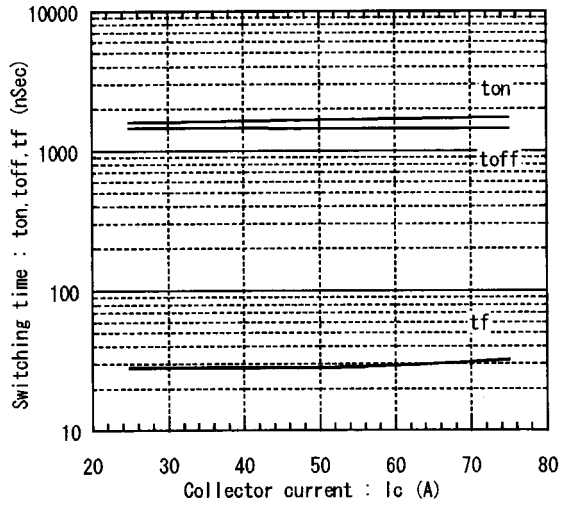
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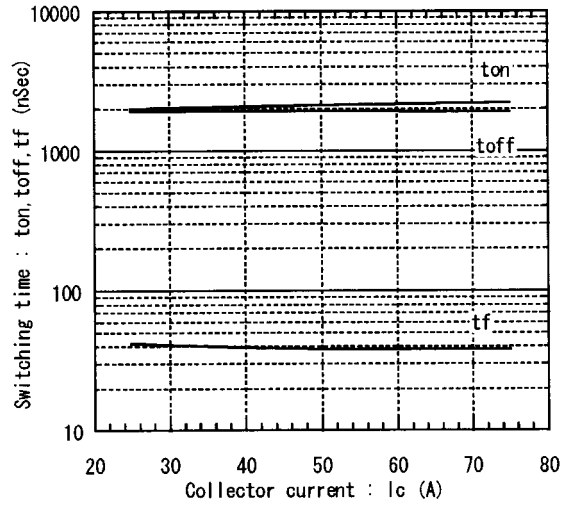


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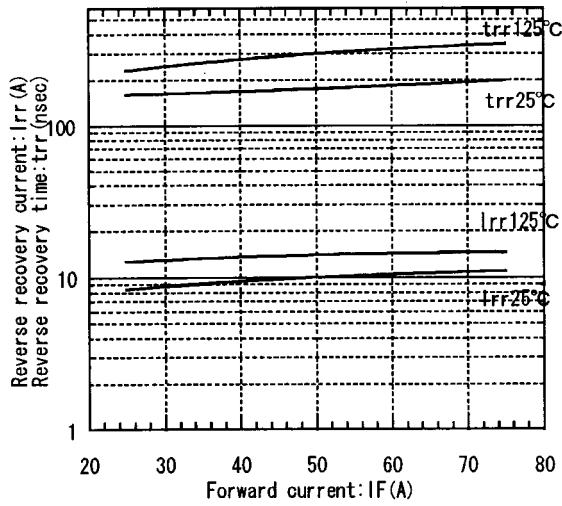
Switching time vs. Collector current
 $E_{dc}=300V, V_{cc}=15V, T_j=25^{\circ}C$



Switching time vs. Collector current
 $E_{dc}=300V, V_{cc}=15V, T_j=125^{\circ}C$

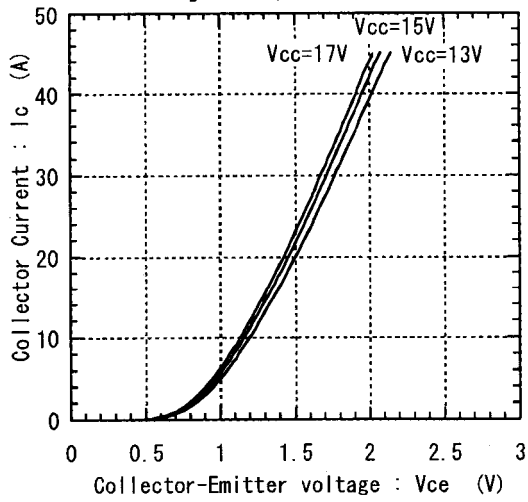


Reverse recovery characteristics
 t_{rr}, I_{rr} vs. I_F

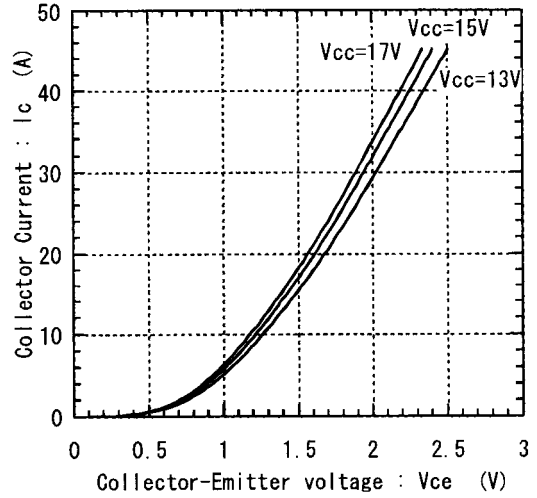


17-3.Dynamic Brake Characteristics (Representative)

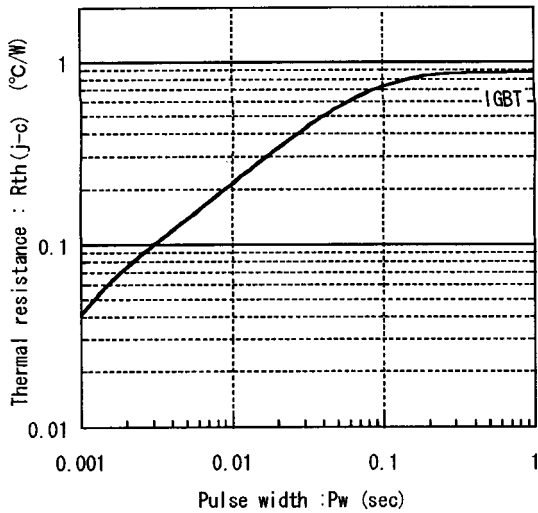
Collector current vs. Collector-Emittor voltage
 $T_j=25^\circ\text{C}$ (Terminal)



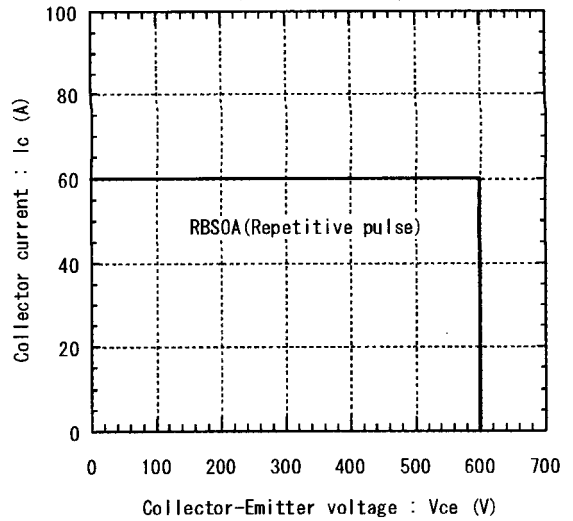
Collector current vs. Collector-Emittor voltage
 $T_j=125^\circ\text{C}$ (Terminal)



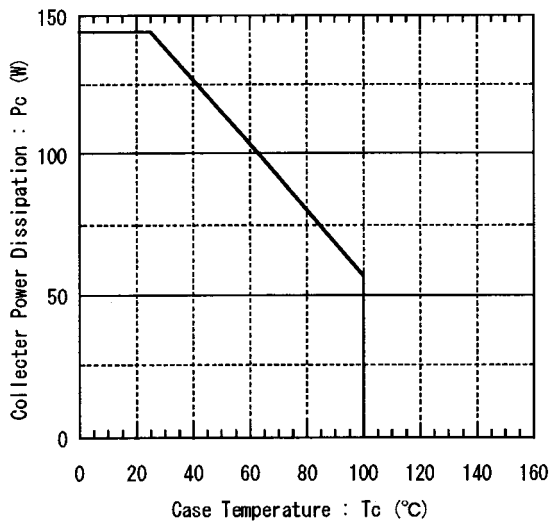
Transient thermal resistance



Reversed biased safe operating area
 $V_{cc}=15\text{V}, T_j \leq 125^\circ\text{C}$



Power derating for IGBT
(per device)



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18-1 .Reliability Test Items

Reliability Test Items

Test categories	Test items	Test methods and conditions	Reference norms EIAJ ED-4071	Number of sample	Acceptance number
Mechanical Tests	1 Terminal Strength 端子強度 (Pull test)	Pull force : 40Nm(main terminal) 10Nm(control terminal) Test time : 10±1 sec.	A - 111 Method 1	5	(1 : 0)
	2 Mounting Strength 締め付け強度	Screw torque : 2.5 ~ 3.5 N·m (M5) Test time : 10±1 sec.	A - 112 Method 2	5	(1 : 0)
	3 Vibration 振動	Range of frequency : 10 ~ 500Hz Sweeping time : 15 min. Acceleration : 100m/s ² Sweeping direction : Each X,Y,Z axis Test time : 6 hr. (2hr./direction)	A - 121	5	(1 : 0)
	4 Shock 衝撃	Maximum acceleration : 10000m/s ² 0.5m/s Direction : Each X,Y,Z axis Test time : 3 times/direction	A - 122	5	(1 : 0)
	5 Solderability はんだ付け性	Solder temp. : 230±5 Immersion time : 5±1sec. Test time : 1 time Each terminal should be Immersed in solder within 1~1.5mm from the body.	A - 131	5	(1 : 0)
	6 Resistance to Soldering Heat はんだ耐熱性	Solder temp. : 260±5 Immersion time : 10±1sec. Test time : 1 time Each terminal should be Immersed in solder within 1~1.5mm from the body.	A - 132	5	(1 : 0)
Environment Tests	1 High Temperature Storage 高温保存	Storage temp. : 125±5 Test duration : 1000hr.	B - 111	5	(1 : 0)
	2 Low Temperature Storage 低温保存	Storage temp. : -40±5 Test duration : 1000hr.	B - 112	5	(1 : 0)
	3 Temperature Humidity Storage 高温高湿保存	Storage temp. : 85±3 Relative humidity : 85±5% Test duration : 1000hr.	B - 121	5	(1 : 0)
	4 Unsaturated Pressure Cooker プレッシャークッカー	Test temp. : 120 ± 2 Atmospheric pressure : 1.7×10 ⁵ Pa Test humidity : 85±5% Test duration : 20hr.	B - 123	5	(1 : 0)
	5 Temperature Cycle 温度サイクル	Test temp. : $\begin{cases} \text{Low temp. } -40^{-5} \\ \text{High temp. } 125^{+5} \\ \text{RT } 5 \sim 35 \end{cases}$ Dwell time : High ~ RT ~ Low ~ RT 1hr. 0.5hr. 1hr. 0.5hr. Number of cycles : 100 cycles	B - 131	5	(1 : 0)
	6 Thermal Shock 熱衝撃	Test temp. : $\begin{cases} \text{High temp. } 100^{+0} \\ \text{Low temp. } 0^{-5} \end{cases}$ Used liquid : Water with ice and boiling water Dipping time : 5 min. par each temp. Transfer time : 10 sec. Number of cycles : 10 cycles	B - 141	5	(1 : 0)

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1 8 - 2 . Reliability Test Items

Test categories	Test items	Test methods and conditions	Reference norms EIAJ ED-4071	Number of sample	Acceptance number
Endurance Tests	1 High temperature Reverse Bias 高温逆バイアス	Test tempm. : $T_a = 125^{+0}_{-5}$ (T_j 150) Bias Voltage : $V_C = 0.8 \times V_{CES}$ Bias Method : Applied DC voltage to C-E $V_{cc} = 15V$ Test duration : 1000hr.	D - 313	5	(1 : 0)
	2 Temperature humidity bias 高温高湿バイアス	Test tempm. : 85 ± 3 Relative humidity : $85 \pm 5\%$ Bias Voltage : $V_C = 0.8 \times V_{CES}$ $V_{cc} = 15V$ Bias Method : Applied DC voltage to C-E Test duration : 1000hr.	B- 121	5	(1 : 0)
	3 Intermitted Operating Life (Power cycle) 断続動作	ON time : 2 sec. OFF time : 18 sec. Test tempm. : $\Delta T_j = 100 \pm 5$ deg T_j 150 , $T_a = 25 \pm 5$ Number of cycles : 15000 cycles	D - 322	5	(1 : 0)

1 9 . Failure Criteria

Item	Characteristic	Symbol	Failure criteria		Unit	Note	
			Lower limit	Upper limit			
Electrical characteristic	Leakage current	ICES	-	USLx2	mA		
	Saturation voltage	VCE(sat)	-	USLx1.2	V		
	Forward voltage	VF	-	USLx1.2	V		
	Thermal resistance	IGBT	Rth(j-c)	-	USLx1.2	/W	
		FWD	Rth(j-c)	-	USLx1.2	/W	
	Over Current Protection	Ioc	LSLx0.8	USLx1.2	A		
	Alarm signal hold time	tALM	LSLx0.8	USLx1.2	ms		
	Over heating Protection	TcOH	LSLx0.8	USLx1.2			
	Isolation voltage	Viso	Broken insulation		-		
Visual inspection	Visual inspection						
	Peeling Plating and the others	-	The visual sample		-		

LSL : Lower specified limit.

USL : Upper specified limit.

Note : Each parameter measurement read-outs shall be made after stabilizing the components at room ambient for 2 hours minimum, 24 hours maximum after removal from the tests. And in case of the wetting tests, for example, moisture resistance tests, each component shall be made wipe or dry completely before the measurement.

Fuji Electric Co.,Ltd.

DWG. NO.

MS6M0672

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H04-004-03

Warnings

1. This product shall be used within its absolute maximum rating (voltage, current, and temperature). This product may be broken in case of using beyond the ratings.

製品の絶対最大定格(電圧, 電流, 温度等)の範囲内で御使用下さい。絶対最大定格を超えて使用すると、素子が破壊する場合があります。

2. Connect adequate fuse or protector of circuit between three-phase line and this product to prevent the equipment from causing secondary destruction.

万一の不慮の事故で素子が破壊した場合を考慮し、商用電源と本製品の間に適切な容量のヒューズ又はブレーカーを必ず付けて2次破壊を防いでください。

3. When studying the device at a normal turn-off action, make sure that working paths of the turn-off voltage and current are within the RBSOA specification. And, when studying the device duty at a short-circuit current non-repetitive interruption, make sure that the paths are also within the avalanche proof (PAV) specification which is calculated from the snubber inductance, the IPM inner inductance and the turn-off current. In case of use of IGBT-IPM over these specifications, it might be possible to be broken.

通常のターンオフ動作における素子責務の検討の際には、ターンオフ電圧・電流の動作軌跡がRBSOA仕様内にあることを確認して下さい。また、非繰返しの短絡電流遮断における素子責務の検討に際しては、スナバーインダクタンスとIPM内部インダクタンス及びターンオフ電流から算出されるアバランシェ耐量(PAV)仕様内であることを確認して下さい。これらの仕様を越えて使用すると、素子が破壊する場合があります。

4. Use this product after realizing enough working on environment and considering of product's reliability life. This product may be broken before target life of the system in case of using beyond the product's reliability life.

製品の使用環境を十分に把握し、製品の信頼性寿命が満足できるか検討の上、本製品を適用して下さい。製品の信頼性寿命を超えて使用した場合、装置の目標寿命より前に素子が破壊する場合があります。

5. If the product had been used in the environment with acid, organic matter, and corrosive gas (For example : hydrogen sulfide, sulfuric acid gas), the product's performance and appearance can not be ensured easily.

酸・有機物・腐食性ガス(硫化水素, 亜硫酸ガス等)を含む環境下で使用された場合、製品機能・外観などの保証は致しかねます。

6. Use the product within the power cycle curve. (The technical Rep.No. : MT6M4057)

本製品は、パワーサイクル寿命カーブ以下で使用下さい。(技術資料 No.: MT6M4057)

7. Never add mechanical stress to deform the main or control terminal.

The deformed terminal may cause poor contact problem.

主端子及び制御端子に応力を与えて変形させないで下さい。端子の変形により、接触不良などを引き起こす場合があります。

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8. According to the outline drawing, select proper length of screw for main terminal. Longer screws may break the case.

本製品に使用する主端子用のネジの長さは、外形図に従い正しく選定下さい。ネジが長いとケースが破損する場合があります。

9. If excessive static electricity is applied to the control terminals, the devices can be broken. Implement some countermeasures against static electricity.

制御端子に過大な静電気が印加された場合、素子が破壊する場合があります。取り扱い時は静電気対策を実施して下さい。

Caution

1. Fuji Electric is constantly making every endeavor to improve the product quality and reliability. However, semiconductor products may rarely happen to fail or malfunction. To prevent accidents causing injury or death, damage to property like by fire, and other social damage resulted from a failure or malfunction of the Fuji Electric semiconductor products, take some measures to keep safety such as redundant design, spread-fire-preventive design, and malfunction-protective design..

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2. The application examples described in this specification only explain typical ones that used the Fuji Electric products. This specification never ensure to enforce the industrial property and other rights, nor license the enforcement rights.

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3. The product described in this specification is not designed nor made for being applied to the equipment or systems used under life-threatening situations. When you consider applying the product of this specification to particular used, such as vehicle-mounted units, shipboard equipment, aerospace equipment, medical devices, atomic control systems and submarine relay equipment or systems, please apply after confirmation of this product to be satisfied about system construction and required reliability.

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